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(12) **United States Design Patent**
Ito et al.

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(54) **SUBSTRATE FOR SPECTROSCOPIC ANALYSIS**

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(**) Term: **14 Years**

(21) Appl. No.: **29/477,957**

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(51) **LOC (10) Cl.** **24-02**

(52) **U.S. Cl.**
USPC **D24/225**

(58) **Field of Classification Search**
USPC D24/216, 222–226, 231, 232, 169; D10/80, 81; 422/99, 100, 102, 68.1, 422/69, 560–566; 435/288.1, 288.3, 289.1, 435/283.1; 436/165
See application file for complete search history.

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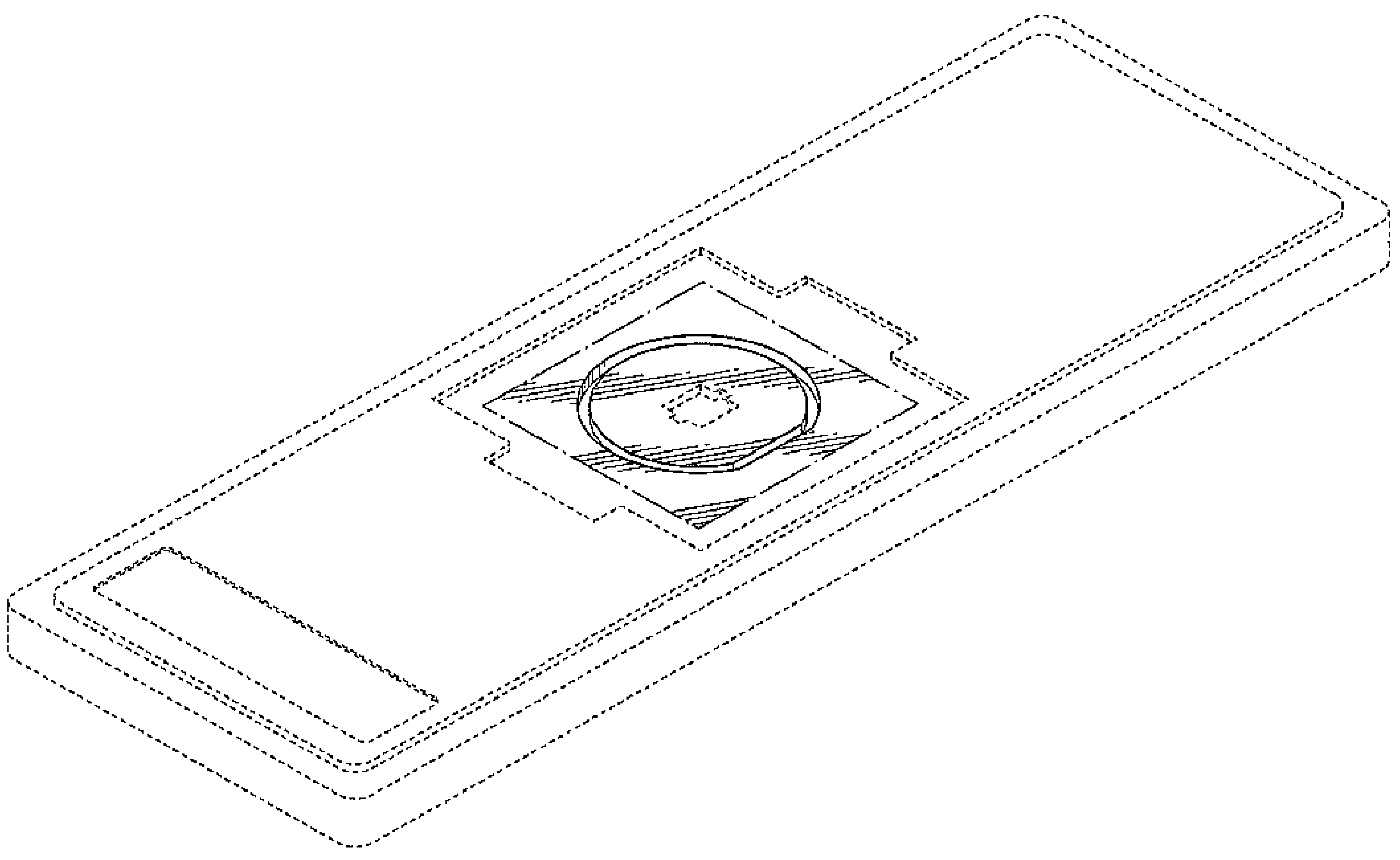
(57) **CLAIM**

The ornamental design for a substrate for spectroscopic analysis, as shown and described.

DESCRIPTION

FIG. **1** is a front view of a substrate for spectroscopic analysis of our new design with the cap portion in place.
FIG. **2** is a rear view of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **3** is a top plan view of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **4** is a bottom view of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **5** is a right side view of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **6** is a left side view of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **7** is a perspective of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **8** is a top plan view without the cover part of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **9** is a perspective view without the cover part of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **10** is a sectional view taken along the line **10-10** of the substrate for spectroscopic analysis of FIG. **3**.
FIG. **11** is a sectional view taken along the line **11-11** of the substrate for spectroscopic analysis of FIG. **1**.
FIG. **12** is a sectional view taken along the line **12-12** of the substrate for spectroscopic analysis of FIG. **8**.
FIG. **13** is an enlarged sectional view taken along the line **13-13** of the substrate for spectroscopic analysis of FIG. **10**; and,
FIG. **14** is a reference sectional view taken along the line **10-10** of the substrate for spectroscopic analysis of FIG. **3** in use, wherein an element is inserted in the recessed part for an element and a glass plate is set above the cover part.
The features shown in dotted lines depict environmental subject matter only and form no part of the claimed design.
The broken lines having alternating long and short segments define bounds of the claimed design and form no part thereof.
The whole of this article is transparent.

1 Claim, 14 Drawing Sheets



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Leaflet "rSERS™ Raman Enhancing Media," Raman Systems, a wholly owned subsidiary of Agiltron, Inc., www.ramansystems.com.

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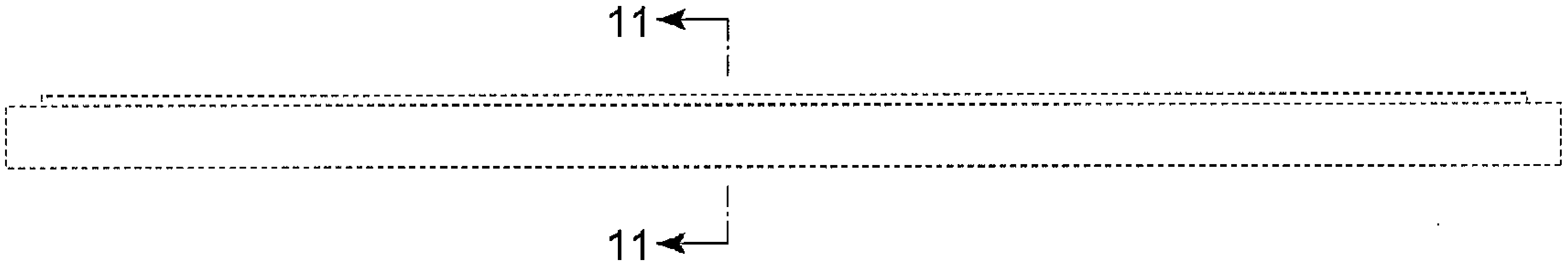


Fig.1

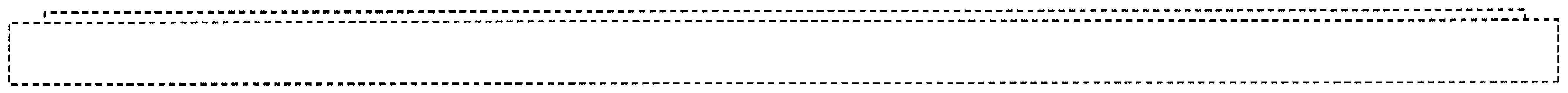
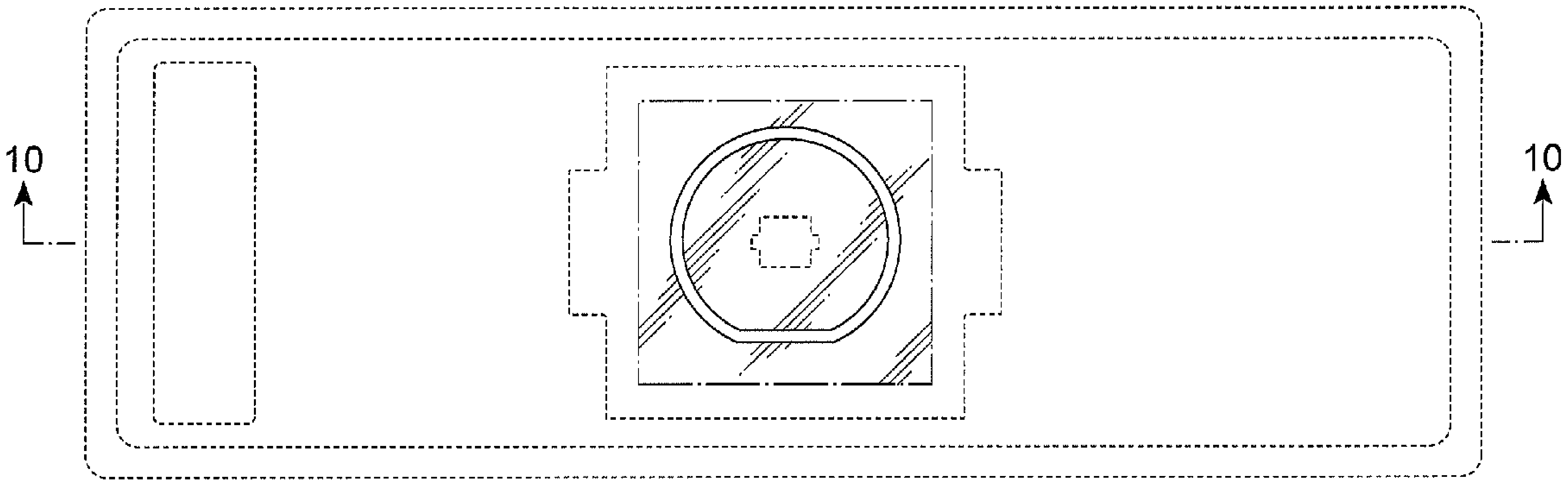


Fig.2



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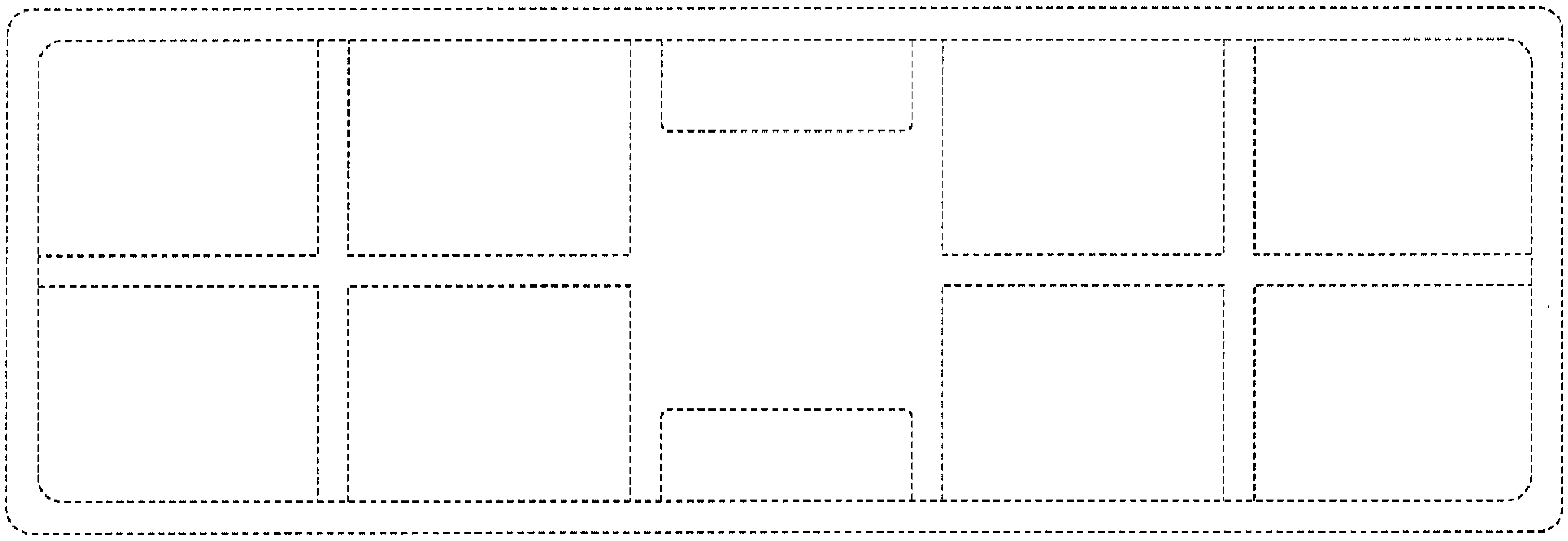

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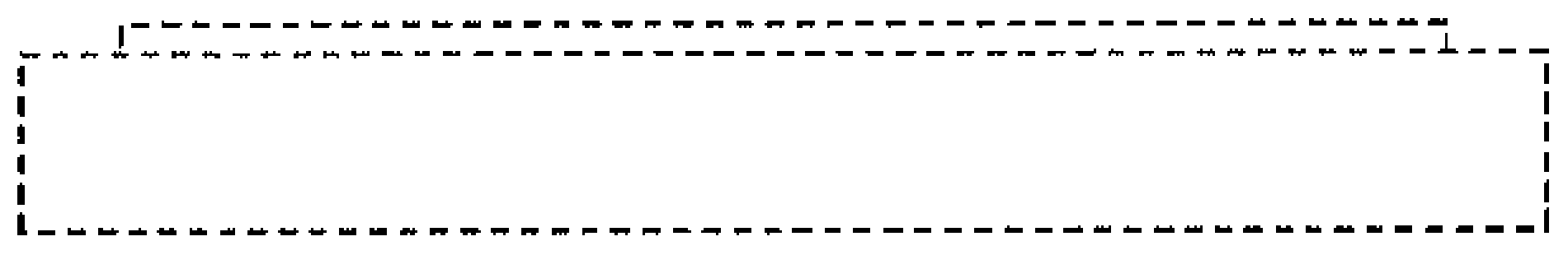
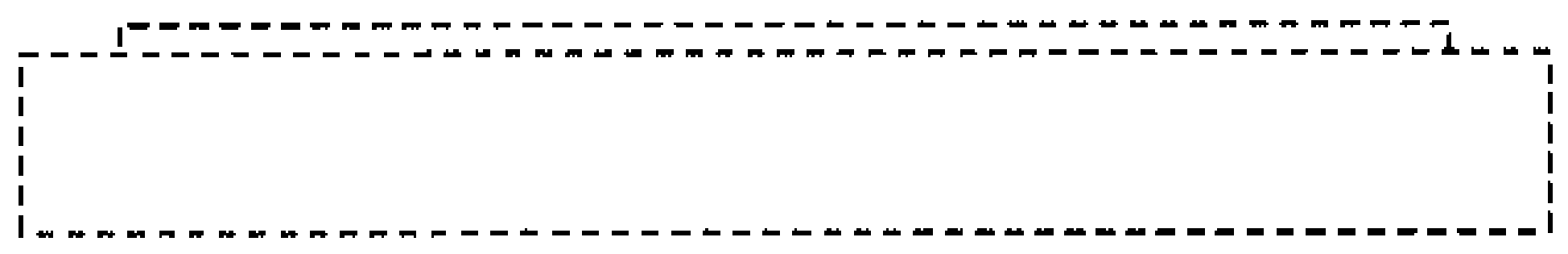


Fig.5



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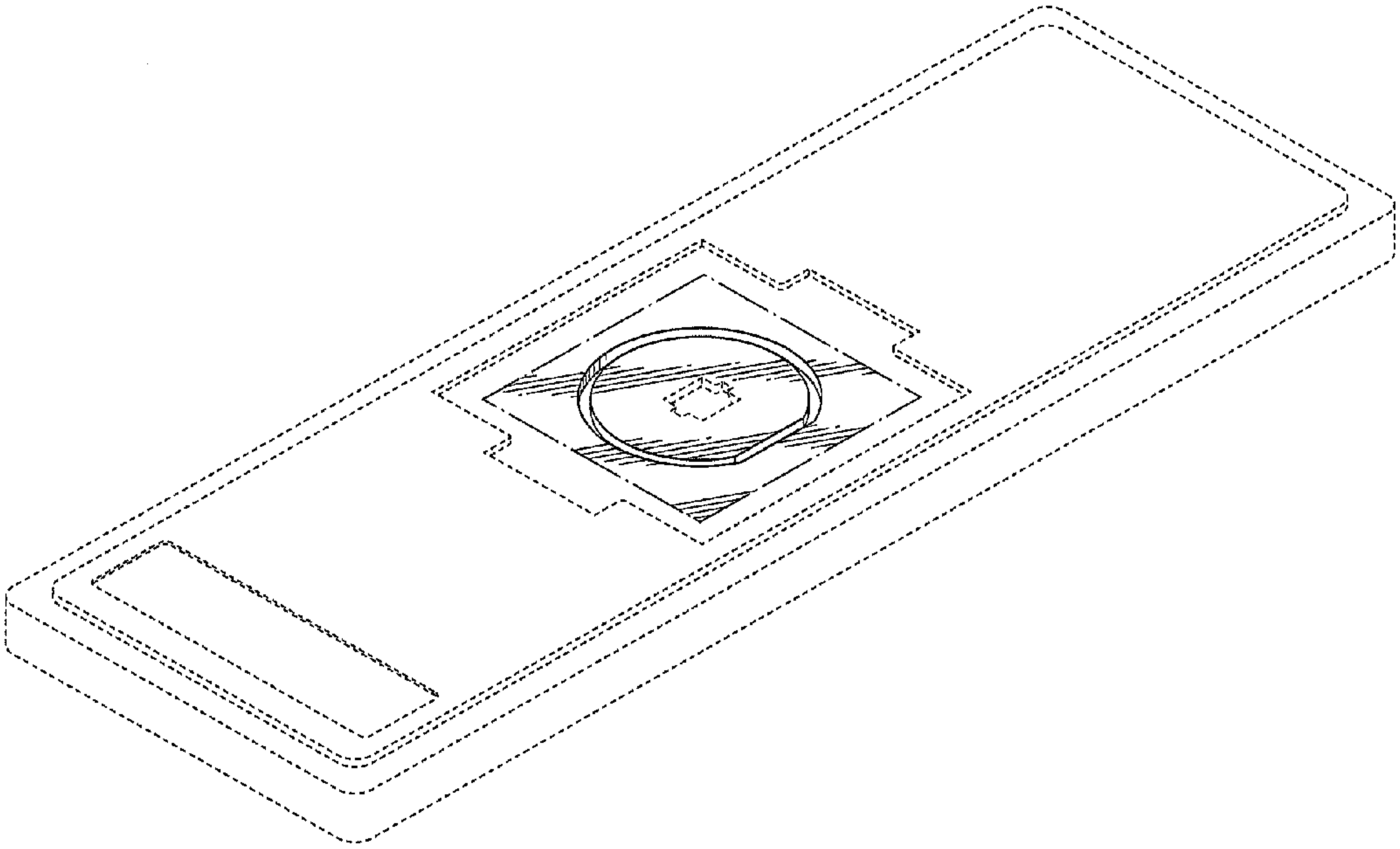

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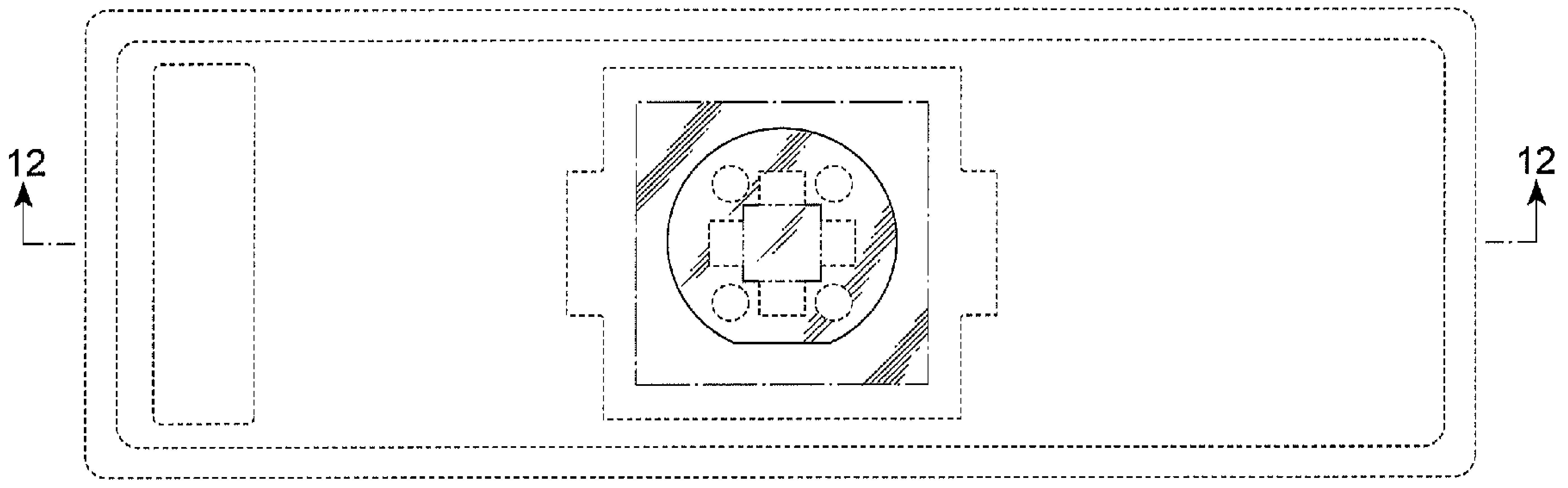

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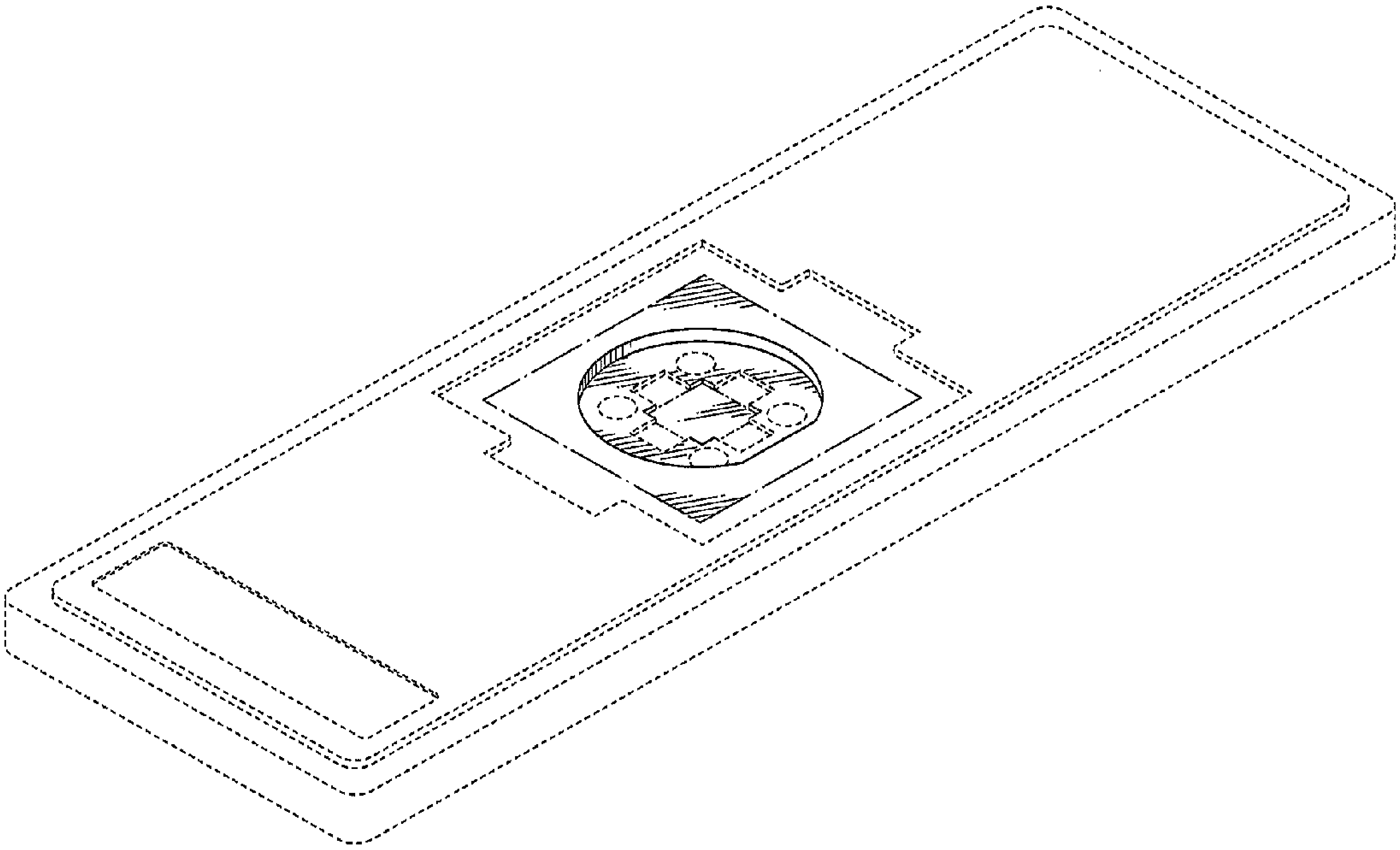
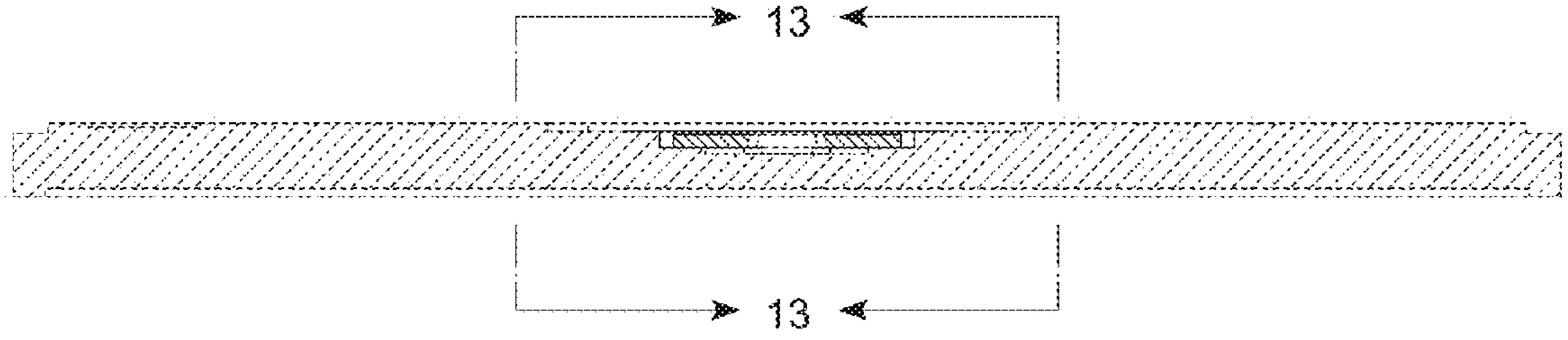


Fig.9



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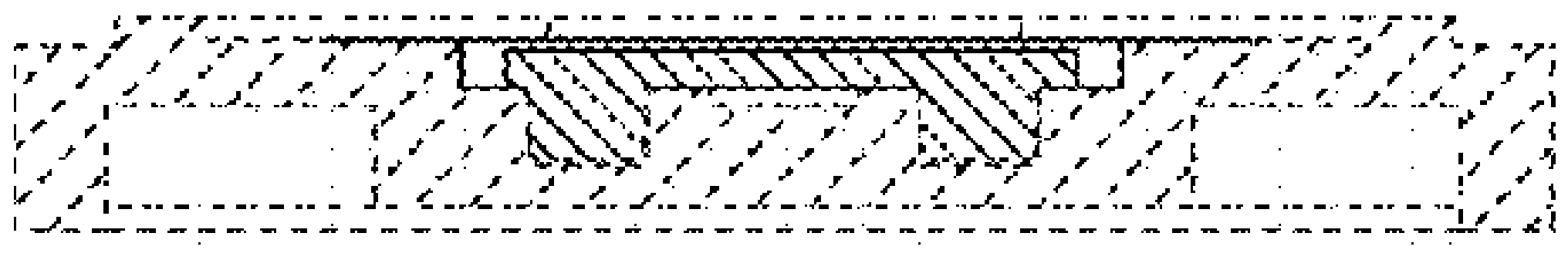

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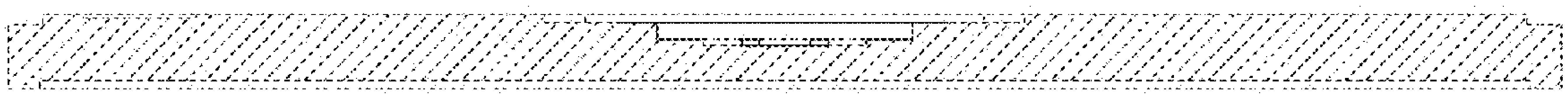

Fig.12

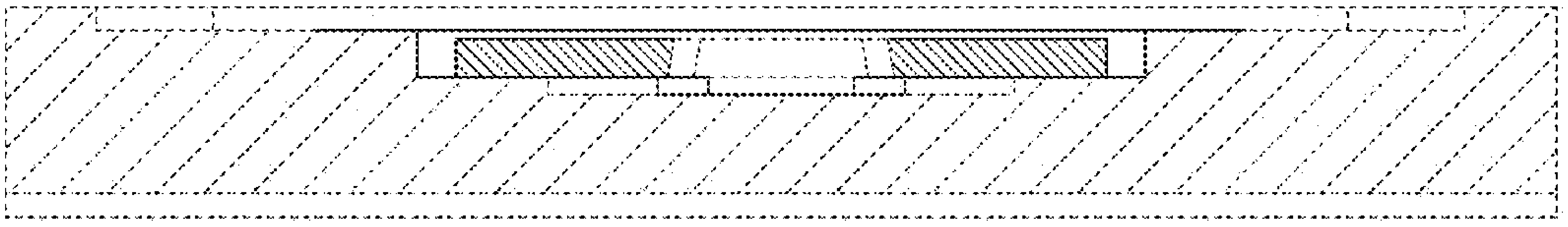

Fig.13

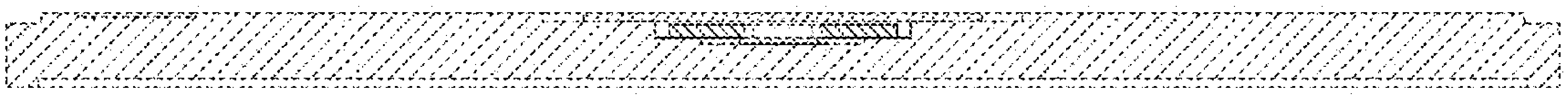

Fig.14